

# ZXCT1022

## Low offset high-side current monitor

### Description

The ZXCT1022 is a precision high-side current sense monitor. Using this type of device eliminates the need to disrupt the ground plane when sensing a load current.

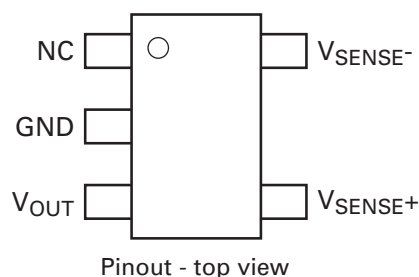
The ZXCT1022 provides a fixed gain of 100 for applications where minimal sense voltage is required.

The very low offset voltage enables a typical accuracy of 3% for sense voltages of only 10mV,

### Features

- Accurate high-side current sensing
- Ground referred output
- 2.5V – 20V supply range
- 25 $\mu$ A quiescent current
- SOT23-5 package

### Pinout information



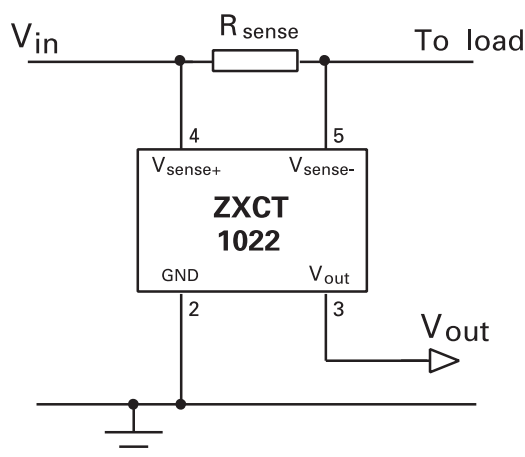
giving better tolerances for small sense resistors necessary at higher currents.

The wide input voltage range of 20V down to as low as 2.5V make it suitable for a range of applications. With a minimum operating current of just 25 $\mu$ A, combined with its SOT23-5 package make it suitable for portable battery equipment too.

### Applications

- Battery chargers
- Smart battery packs
- DC motor control
- Over-current protection
- Power supply current measurement
- Level translating

### Typical application circuit



### Ordering information

Order reference	Package	Device marking	Status	Reel size (inches)	Quantity per reel	Tape width (mm)
ZXCT1022E5TA	SOT23-5	1022	Active	7	3000	8

## Absolute maximum ratings

Voltage on $V_{S+}^{(*)}$ pin	-0.6V to 20V
Voltage on $V_{S-}^{(*)}(\dagger)V_{OUT}^{(*)}(\dagger)$ pin	-0.6V to $V_{S+} + 0.5V$
$V_{SENSE}^{(\ddagger)}$	-0.6V to +0.5V
Operating temperature	-40 to 85°C
Storage temperature	-55 to 150°C
Package power dissipation	( $T_A = 25^\circ C$ )
- SOT23-5	- 450mW

### NOTES:

(\*) with respect to GND pin

(†) voltage not to exceed 20V

(‡)  $V_{SENSE} = V_{S+} - V_{S-}$

## Pinout information

Pin name	Pin function
N/C	Not internally connected
GND	Ground
$V_{OUT}$	Voltage output referenced to GND. Intended to drive high impedance loads
$V_{S-}$	High impedance negative sense voltage input
$V_{S+}$	Supply and positive sense voltage input

## Electrical characteristics test conditions $T_{amb} = 25^{\circ}\text{C}$ , $V_{IN} = 15\text{V}$

Symbol	Parameter	Conditions	Limits			Unit
			Min.	Typ.	Max.	
$V_{IN}$	$V_{CC}$ range		2.5		20	V
$V_{OUT}$	Output voltage	$V_{SENSE} = 0\text{V}$	0	30	100	mV
		$V_{SENSE} = 10\text{mV}$	0.97	1.0	1.03	V
		$V_{SENSE} = 30\text{mV}$	2.91	3.0	3.09	V
		$V_{SENSE} = 100\text{mV}$	9.7	10.0	10.3	V
$R_{OUT}$	Output resistance		10	15	20	$\text{k}\Omega$
$T_C^{(*)}$	Output temperature coefficient			50	300	ppm
$I_Q$	Ground pin current	$V_{SENSE} = 0\text{V}$		25	35	$\mu\text{A}$
$V_{SENSE}^{(\dagger)}$	Sense voltage	$V_{IN} = 20\text{V}$	0		180 <sup>(‡)</sup>	mV
$I_{SENSE}$	Load pin current	$V_{SENSE} = 0\text{V}$			100	nA
Acc	Accuracy	$V_{SENSE} = 10\text{mV}$	-3		3	%
Gain	$V_{OUT} / V_{SENSE}$	$V_{SENSE} = 10\text{mV}$	97	100	103	V/V
BW	Bandwidth	$V_{SENSE} = 10\text{mV}$		300		kHz
		$V_{SENSE} = 100\text{mV}$		2		MHz

### NOTES:

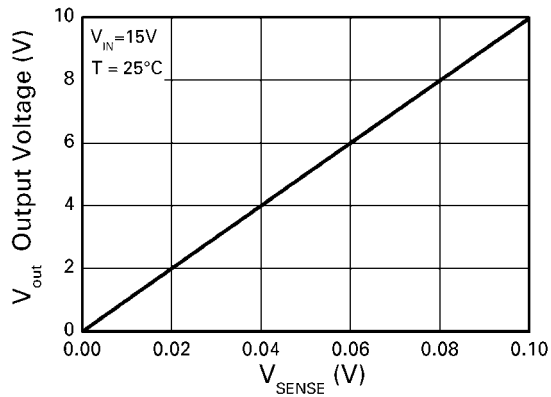
(\*)  $T_C$  limits are determined by characterization

(†)  $V_{SENSE} = V_{IN} - V_{LOAD}$

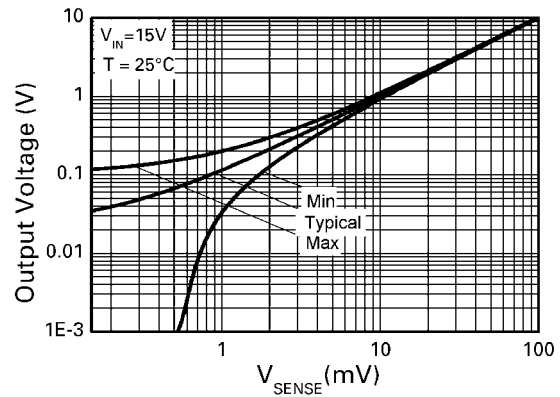
(‡) For linear operation maximum  $V_{SENSE}$  is limited by operating voltage and is approximately:

$$V_{SENSE} = \frac{(V_{IN} - 2)}{100}$$

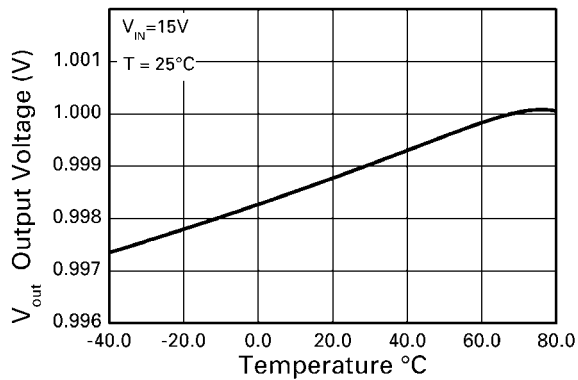
## Typical characteristics



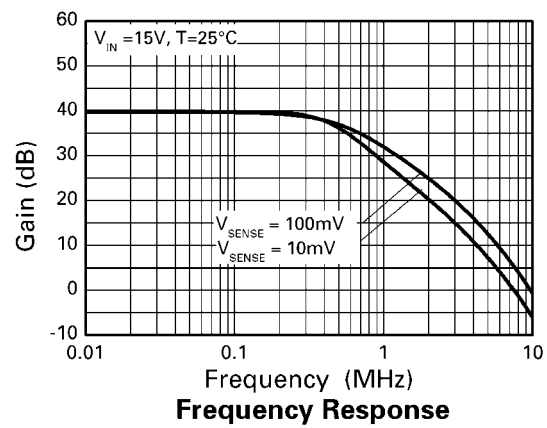
Typical Output v Sense Voltage



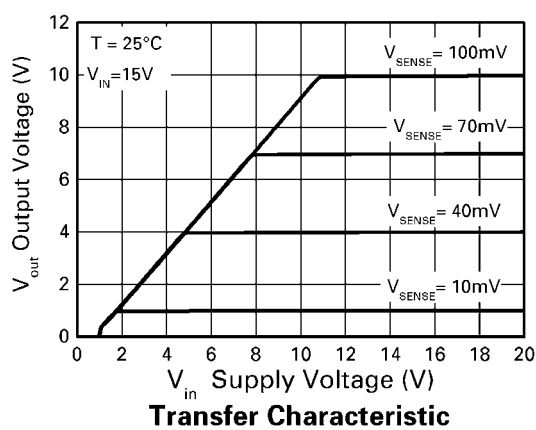
Error v Sense Voltage



Output Voltage v Temperature

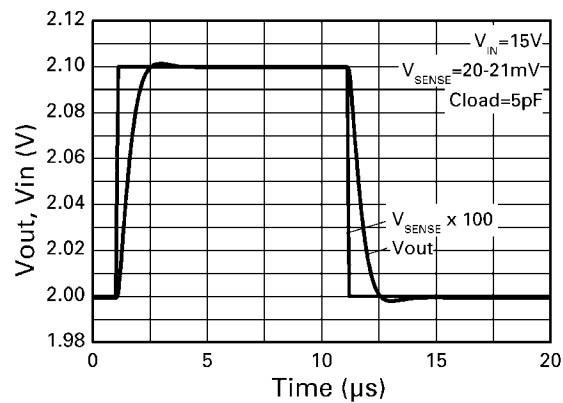


Frequency Response

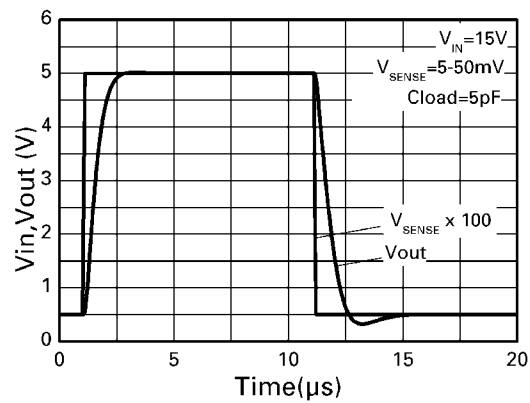


Transfer Characteristic

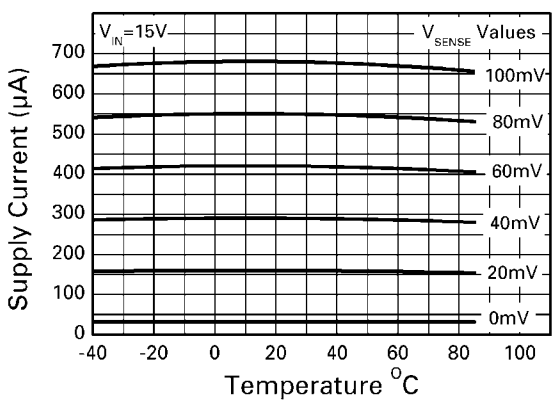
Typical characteristics



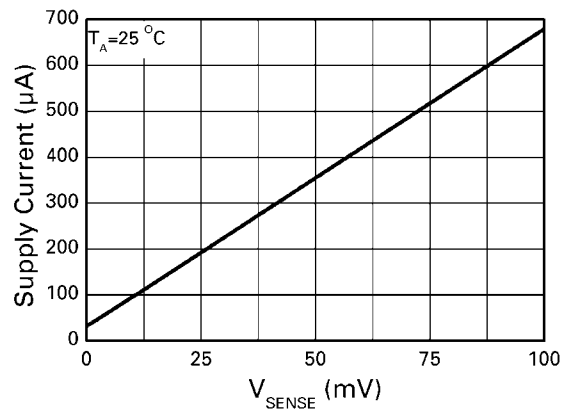
Small Signal Step Response



Large Signal Step Response



Isupply v Temperature



Isupply v Vsense

## Application information

The ZXCT1022 has a fixed dc voltage gain of 100. No external scaling resistors are required for the output. Output voltage is simply defined as:

$$V_{OUT} = 100 \times V_{SENSE} (V)$$

Where  $V_{SENSE} = V_{IN} - V_{LOAD}$

### PCB trace shunt resistor for low cost solution

Figure 1 shows a PCB layout suggestion for a low cost solution where a PCB resistive trace in replacement for a conventional shunt resistor, can be used. The resistor section is 25mm x 0.25mm giving approximately 150mΩ using 1 oz copper. Smaller resistances can be used if required.

Total circuit solution: 1 component. Shows area of 150mΩ sense resistor compared to SOT23 package.

Practical tolerance of the PCB resistor will be around 5% depending on manufacturing methods.

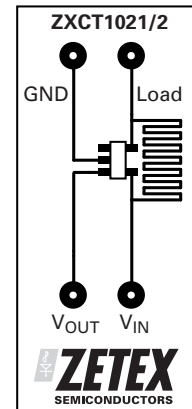
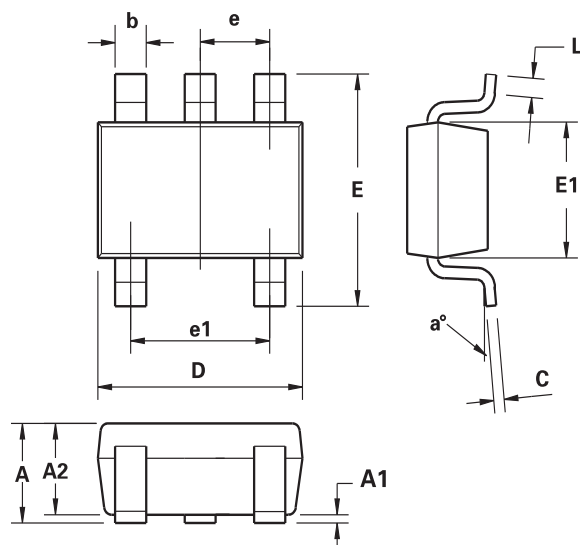


Figure 1 PCB layout suggestion

## Package outline - SOT23-5



DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.90	1.45	0.0354	0.0570
A1	0.00	0.15	0.00	0.0059
A2	0.90	1.30	0.0354	0.0511
b	0.20	0.50	0.0078	0.0196
C	0.09	0.26	0.0035	0.0102
D	2.70	3.10	0.1062	0.1220
E	2.20	3.20	0.0866	0.1181
E1	1.30	1.80	0.0511	0.0708
e	0.95 REF		0.0374 REF	
e1	1.90 REF		0.0748 REF	
L	0.10	0.60	0.0039	0.0236
a°	0°	30°	0°	30°

**Note:** Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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Europe	Americas	Asia Pacific	Corporate Headquarters
Zetex GmbH Kustermann-park Balanstraße 59 D-81541 München Germany Telefon: (49) 89 45 49 49 0 Fax: (49) 89 45 49 49 9 europe.sales@zetex.com	Zetex Inc 700 Veterans Memorial Highway Hauppauge, NY 11788 USA Telephone: (1) 631 360 2222 Fax: (1) 631 360 8222 usa.sales@zetex.com	Zetex (Asia Ltd) 3701-04 Metroplaza Tower 1 Hing Fong Road, Kwai Fong Hong Kong Telephone: (852) 26100 611 Fax: (852) 24250 494 asia.sales@zetex.com	Zetex Semiconductors plc Zetex Technology Park, Chadderton Oldham, OL9 9LL United Kingdom Telephone: (44) 161 622 4444 Fax: (44) 161 622 4446 hq@zetex.com

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